Silicon N-Channel MOS FET

HITACHI

November 1996

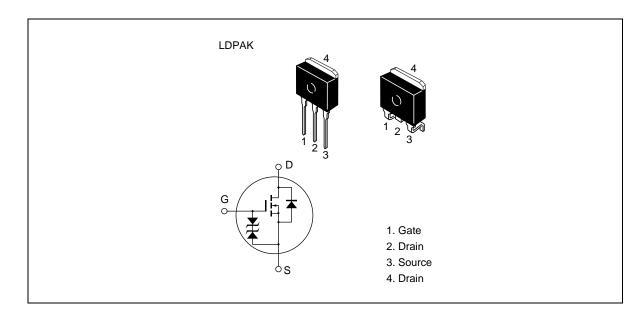
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for Switching regulator, DC DC converter
- Avalanche ratings

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	25	A
Drain peak current	I _{D(pulse)} *1	100	A
Body to drain diode reverse drain current	I _{DR}	25	A
Avalanche current	I_**3	25	A
Avalanche energy	E _{AR} *3	53	mJ
Channel dissipation	Pch*2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW \leq 10 μ s, duty cycle \leq 1 %

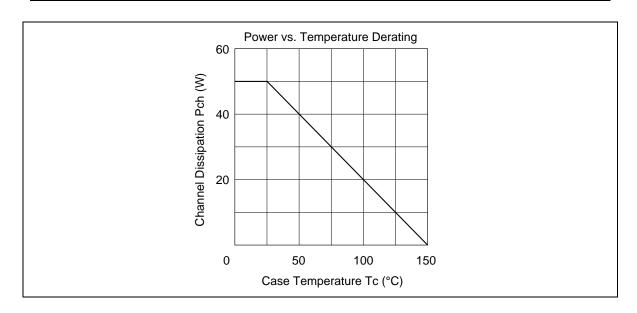
- 2. Value at Tc = 25 $^{\circ}$ C
- 3. Value at Tch = 25 °C, Rg \geq 50 Ω

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.0	_	2.25	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{\scriptscriptstyle DS(on)}$	_	0.03	0.04	Ω	$I_D = 15 \text{ A}$ $V_{GS} = 10 \text{ V}^{*1}$
		_	0.043	0.06	Ω	$I_D = 15 \text{ A}$ $V_{GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	y _{fs}	12	21	_	S	$I_{D} = 15 \text{ A}$ $V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	1450	_	pF	$V_{DS} = 10 \text{ V}$ $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	Coss	_	655	_	pF	_
Reverse transfer capacitance	Crss	_	195	_	pF	_
Turn-on delay time	t _{d(on)}	_	20	_	ns	$I_{D} = 15 A$ $V_{GS} = 10 V$ $R_{L} = 2 \Omega$
Rise time	t _r	_	110	_	ns	_
Turn-off delay time	$\mathbf{t}_{d(off)}$	_	225	_	ns	_
Fall time	t _f	_	145	_	ns	_
Body to drain diode forward voltage	V_{DF}	_	1.2	_	V	I _F = 25 A, V _{GS} = 0
Body to drain diode reverse recovery time	t _{rr}	_	100	_	ns	$I_F = 25 \text{ A}, V_{GS} = 0,$ diF / dt = 50 A / μ s
Rise time Turn-off delay time Fall time Body to drain diode forward voltage Body to drain diode reverse	$\begin{array}{c} t_{r} \\ t_{d(off)} \\ \end{array}$ $\begin{array}{c} t_{f} \\ V_{DF} \end{array}$		110 225 145 1.2	_ _ _ _ _	ns ns ns V	$V_{GS} = 10 \text{ V}$ $R_L = 2 \Omega$ $I_F = 25 \text{ A}, V_{GS} = 0$ $I_F = 25 \text{ A}, V_{GS} = 0,$

Note 1. Pulse Test

See characteristics curves of 2SK1910



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